

DDR S.O.DIMM Socket 200 Positions

1. Scope :

1.1 Contents

This specification covers the requirements for product performance, test methods and quality assurance provisions of DDR S.O.DIMM Socket 200 Positions Combine to Gold Plating S.O.DIMM.

Applicable product description and part numbers are as shown in Appendix 1.

2. Applicable Documents:

The following documents form a part of this specification to the extent specified herein. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence. In the event of conflict between the requirements of this specification and the referenced documents, this specification shall take precedence.

2.1 AMP Specifications :

- A. 109-5000 Test Specification, General Requirements for Test Methods
- B. 501-5361 Test Report (Standard profile)
 - 501-5431 Test Report (Standard profile)
 - 501-5435 Test Report (Low profile)
 - 501-5460 Test Report (6.5 Height)
 - 501-5488 Test Report (9.2 Height)

2.2 Commercial Standards and Specifications :

A. MIL-STD-202

3. Requirements :

3.1 Design and Construction :

Product shall be of the design, construction and physical dimensions specified on the applicable product drawing.

3.2 Materials :

A. Contact :

Copper Alloy Finish: Contact area: Gold Plated Tine area :Gold Plated Underplate :Nickel Plated

B. Housing :

Thermo plastic UL94V-0

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Stainless Steal

D. Floating Peg

Copper Alloy, Tin Plated

3.3 Ratings :

- A. Voltage Rating : 25 VAC
- B. Current Rating : 0.5 A
- C. Temperature Rating :-55 $^{\circ}$ C to 85 $^{\circ}$ C

3.4 Performance Requirements and Test Descriptions :

The product shall be designed to meet the electrical, mechanical and environmental performance requirements specified in Fig. 1. All tests shall be performed in the room temperature, unless otherwise specified.

| Para. | Test Items | Requirements | Procedures | | | | | | |
|-------|-------------------------|---|--|--|--|--|--|--|--|
| 3.5.1 | Examination of Product | Meets requirements of product | Visual inspection | | | | | | |
| | | drawing | No physical damage | | | | | | |
| | | Electrical Requirements | | | | | | | |
| 3.5.2 | Termination Resistance | 30 mΩ Max. (Initial) | Subject mated contacts assembled in | | | | | | |
| | (Low Level) | $\Delta R=20 \text{ m} \Omega$ Max. (Final) | housing to closed circuit current of 10 mA | | | | | | |
| | | | Max. at open circuit voltage of 20mV Max. | | | | | | |
| | | | obtain resistance value by dividing the | | | | | | |
| | | | measured reading into two. | | | | | | |
| | | | Fig. 3-1,3-2. | | | | | | |
| | | | AMP Spec. 109-5311-1 | | | | | | |
| 3.5.3 | Dielectric withstanding | No creeping discharge nor | 0.25 kVAC for 1 minute. | | | | | | |
| | Voltage | flashover shall occur. | Test between adjacent circuits of unmated | | | | | | |
| | | Current leakage : 0.5 mA Max. | connectors. | | | | | | |
| | | | AMP Spec. 109-5301 | | | | | | |
| 3.5.4 | Insulation Resistance | 250MΩ Min.(Initial) | Impressed voltage 500 V DC. | | | | | | |
| | | 50MΩ Min.(Final) | Test between adjacent circuits of unmated | | | | | | |
| | | | connectors. | | | | | | |
| | | | AMP Spec. 109-5302 | | | | | | |
| Para. | Test Items | Requirements | Procedures | | | | | | |
| | | Mechanical Requirements | | | | | | | |
| 3.5.5 | Vibration | No electrical discontinuity | Subject mated connectors to 10-55-10 Hz | | | | | | |
| | (Low Frequency) | greater than 0.1 μ sec. shall | traversed in 1 minute at 1.52 mm | | | | | | |
| | | occur. | amplitude | | | | | | |
| | | $\Delta R=20 \text{ m} \Omega$ Max. (Final) | 2 hours each of 3 mutually perpendicular | | | | | | |
| | | | planes. | | | | | | |
| | | | 100 mA applied. | | | | | | |
| | | | AMP Spec. 109-5201 | | | | | | |
| | | | | | | | | | |

3.5 Test Requirements and Procedures Summary

| 3.5.6 | Physical Shock | No electrical discontinuity | Accelerated Velocity : 490 m/s ² (50 G) | | | | | | |
|---------|------------------------|---|---|--|--|--|--|--|--|
| | | greater than 0.1 μ sec. shall | Waveform : Half sine | | | | | | |
| | | occur. | Duration : 11 m sec. | | | | | | |
| | | $\Delta R=20 \text{ m} \Omega$ Max. (Final) | Number of Drops: 3 drops each to normal | | | | | | |
| | | | and reversed directions of X, Y and Z | | | | | | |
| | | | axes, totally 18 drops. | | | | | | |
| | | | AMP Spec. 109-5208 | | | | | | |
| | | | Condition A | | | | | | |
| 3.5.7 | P.C.Board Mating Force | 200 Pos. : 59.8N (6.1 kgf) Max. | Operation Speed : 100 mm/min. | | | | | | |
| | | | Measure the force required to mate | | | | | | |
| | | | connectors.(In this test, the force required | | | | | | |
| | | | to turn PCB before it engages on lacking, | | | | | | |
| | | | is excluded.) | | | | | | |
| | | | AMP Spec. 109-5206 Condition B | | | | | | |
| Para. | Test Items | Requirements | Procedures | | | | | | |
| 3.5.8 | Durability | $\Delta R=20 \text{ m}\Omega$ Max. (Final) | Repeated insertion and extraction of P.C.B | | | | | | |
| 0.010 | (Repeated | | to and from the connector with the turns to | | | | | | |
| | Mate/Unmating) | | lock it and then unlock it for 25 cycles. | | | | | | |
| 3.5.9 | Solder ability | Wet Solder Coverage : | Solder Temperature : 245 \pm 5 \circ C | | | | | | |
| 0.0.0 | Colder ability | 95 % Min. | Immersion Duration : 5 \pm 0.5 seconds | | | | | | |
| | | | Flux : Alpha 100 | | | | | | |
| | | | | | | | | | |
| | | Environmentel Dequiremen | AMP Spec. 109-5203 | | | | | | |
| 0 5 4 0 | | Environmental Requiremen | | | | | | | |
| 3.5.10 | Resistance to Reflow | No physical damage shall | Test connector on P.C.Board Pre-Heat150~180°C :90±30sec. | | | | | | |
| | Soldering Heat | occur | Heat 230°C Min. $:30\pm 10$ sec. | | | | | | |
| | | | Heat Peak260°C Max. See Fig.4-2 | | | | | | |
| | | | OR | | | | | | |
| | | | Apply to JEDEC standard | | | | | | |
| | | | (J-STD-020C) | | | | | | |
| 3.5.11 | Thermal Shock | $\Delta R=20 \text{ m} \Omega$ Max. (Final) | Mated connector | | | | | | |
| | | | −55 °C / 30 min., | | | | | | |
| | | | 85℃ / 30 min. | | | | | | |
| | | | Making this a cycle, repeat 5 cycles. | | | | | | |
| | | | AMP Spec. 109-5103 Condition A | | | | | | |
| Para. | Test Items | Requirements | Procedures | | | | | | |
| 3.5.12 | Humidity-Temperature | Insulation resistance | Mated connector, 25~65℃, | | | | | | |
| | Cycling | 50 MΩ Min. (final) | 90~95 % R. H. 5 cycles | | | | | | |
| | | ΔR =20 m Ω Max. (Final) | Cold shock −10°C performed | | | | | | |
| | | | AMP Spec. 109-5106 | | | | | | |
| 3.5.13 | Salt Spray | $\Delta R=20 \text{ m}\Omega$ Max. (Final) | Subject mated connectors to 5 % salt | | | | | | |
| | | | concentration for 24 hours : | | | | | | |
| | | | AMP Spec. 109-5101 Condition A | | | | | | |
| | | ∆R=20 mΩ Max. (Final) | Mated connector | | | | | | |
| 351/ | Industrial Gas (SO2) | | | | | | | | |
| 3.5.14 | Industrial Gas (SO2) | $\Delta R = 20$ max. (1 mat) | | | | | | | |
| 3.5.14 | Industrial Gas (SO2) | ΔΛ-20 III32 IIIax. (I IIIaT) | SO2 Gas : 10 ppm, 95 % R. H. | | | | | | |
| 3.5.14 | Industrial Gas (SO2) | ΔΛ-20 III32 IIIax. (1111a1) | | | | | | | |



| 3.5.15 | Temperature Life | ΔR =20 m Ω Max. | (Final) | Mated connector |
|--------|------------------|--------------------------------|---------|-----------------------|
| | (Heat Aging) | | | 85℃, Duration :2 days |
| | | | | AMP Spec. 109-5104 |
| | | | | Condition A |

4. Product Qualification Test Sequence

| | Test Group | | | | | | | | | | | |
|--|------------|-------------------|------|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| Test Examination | | 2(b) | 3(b) | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 |
| | | Test Sequence (a) | | | | | | | | | | |
| Examination of Product | 1,7 | 1,5 | 1,5 | 1,3 | 1,5 | 1,3 | 1,3 | 1,5 | 1,5 | 1,5 | 1,5 | 1,5 |
| Termination Resistance (Low Level) | | 2,4 | 2,4 | | 2,4 | | | 2,4 | 2,4 | 2,4 | 2,4 | 2,4 |
| Dielectric withstanding Voltage | 3,6 | | | | | | | | | | | |
| Insulation Resistance | 2,5 | | | | | | | | | | | |
| Vibration (Low Frequency) | | 3 | | | | | | | | | | |
| Physical Shock | | | 3 | | | | | | | | | |
| Connector Mating Force | | | | 2 | | | | | | | | |
| Durability (Repeated Mate/Unmating) | | | | | 3 | | | | | | | |
| Solderability | | | | | | 2 | | | | | | |
| Resistance to Reflow Soldering Heat | | | | | | | 2 | | | | | |
| Thermal Shock | | | | | | | | 3 | | | | |
| Temperature Humidity Cycling | 4 | | | | | | | | | | | 3 |
| Salt Spray | | | | | | | | | 3 | | | |
| Industrial SO ₂ Gas | | | | | | | | | | 3 | | |
| Temperature Life (Heat Aging) | | | | | | | | | | | 3 | |



(a) Numbers indicate sequence in which the tests are performed.

(b) Discontinuities shall nit take place in this test group, during tests.



Fig.3-1 Termination Resistance Mesuring Points.



Fig.4 Temperature Profile of Reflow Soldering